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By:

*W. Stemmer*

Date:

*March 17, 2003*

#11  
Translation  
J. McCumelles  
6/11/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Lothar Bauch et al. /

Applic. No. : 10/082,554 /

Filed : February 25, 2002 /

Title : Stacked VIA with Specially Designed Landing Pad for Integrated Semiconductor Structures

Examiner : Pershelle L. Greene

Group Art Unit: 2826

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LETTER

Hon. Commissioner of Patents and Trademarks,  
Washington, D. C. 20231

Sir:

As indicated on page 8, third paragraph, of counsel's amendment filed in the Patent Office on January 13, 2003, enclosed please find a certified translation of the German priority application number 199 39 852.6, filed August 23, 1999. A claim for priority is also enclosed.

Respectfully submitted,

*W. Stemmer*

For Applicants

/tk

WERNER H. STEMER  
REG. NO. 34,956

March 17, 2003

Lerner and Greenberg, P.A.  
Post Office Box 2480  
Hollywood, FL 33022-2480  
Tel: (954) 925-1100  
Fax: (954) 925-1101